

Features

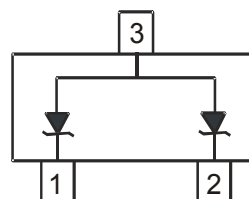
- Provides ESD Protection per IEC 61000-4-2 Standard:
Air – $\pm 30\text{kV}$, Contact – $\pm 30\text{kV}$
- 200W Peak Power Dissipation
- Typically Used to Protect LIN and CAN Transceiver from ESD and other Harmful Transient Voltage Events
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- Halogen and Antimony Free. "Green" Device (Note 3)**

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208③
- Weight: 0.009 grams (Approximate)



Top View



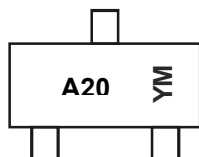
Device Schematic

Ordering Information (Note 4)

Product	Compliance	Marking	Reel size(inches)	Tape width(mm)	Quantity per reel
DESD32VS2SO-7	AEC-Q101	A20	7	8	3,000/Tape & Reel

- Notes:
- No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 - See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 - For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



A20 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: A = 2013)
 M = Month (ex: 9 = September)

Date Code Key

Year	2013	2014	2015	2016	2017	2018	2019
Code	A	B	C	D	E	F	G

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P _{PP}	200	W	8/20μs, Per in Figure 3
Peak Pulse Current	I _{PP}	4	A	8/20μs, Per in Figure 3
ESD Protection – Contact Discharge	V _{ESD_Contact}	±30	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V _{ESD_Air}	±30	kV	Standard IEC 61000-4-2
ESD Protection – Human Body Model	V _{ESD_HBM}	±16	kV	MIL-STD-883
Electrical Fast Transient Current	I _{EFT}	80	A	Standard IEC 61000-4-4(EFT)

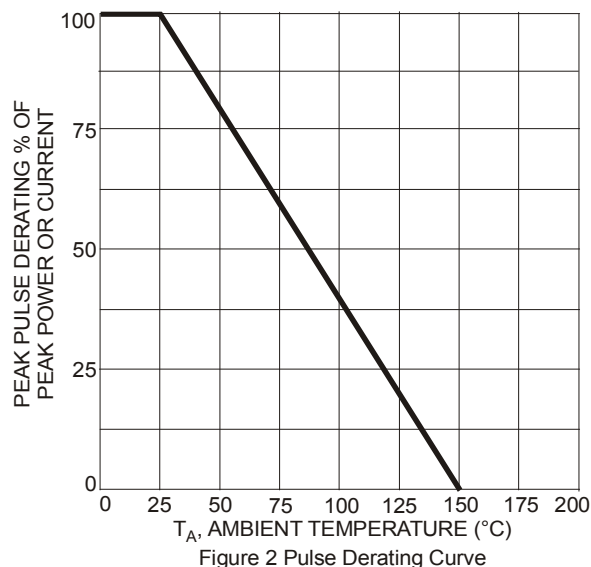
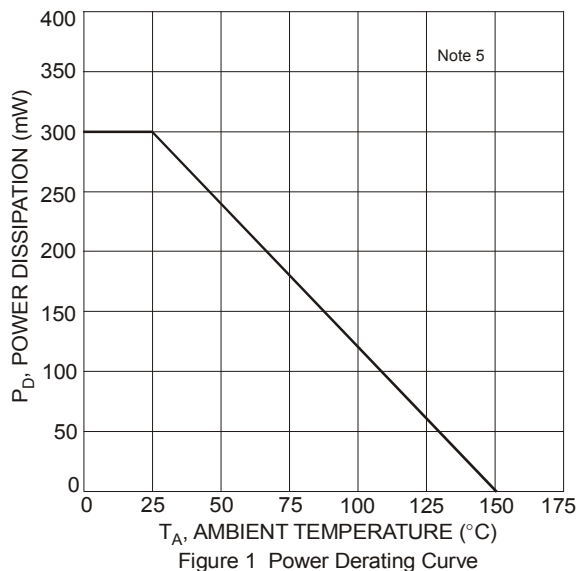
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P _D	300	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _{ΘJA}	417	°C/W
Operating Junction Temperature Range	T _J	-65 to +150	°C
Storage Temperature Range	T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Working Voltage	V _{RWM}	—	—	32	V	—
Breakdown Voltage	V _{BR}	34	—	40	V	I _R = 1.0mA
Reverse Leakage Current (Note 6)	I _R	—	—	100	nA	V _{RWM} = 32V
Clamping Voltage (Note 7)	V _{CL}	—	—	42	V	I _{PP} = 1A, t _p = 8/20μs
		—	—	50	V	I _{PP} = 4A, t _p = 8/20μs
Channel Input Capacitance	C _T	—	36	42	pF	V _{IN} = 0V, f = 1MHz, Pin 1 or Pin 2 to Pin 3
		—	18	21	pF	V _{IN} = 0V, f = 1MHz, between Pin 1 and Pin 2

Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at <http://www.diodes.com>.
 6. Short duration pulse test used to minimize self-heating effect.
 7. Measured from pin 1 or pin 2 to pin 3; Non-repetitive current pulse per Figure 3.



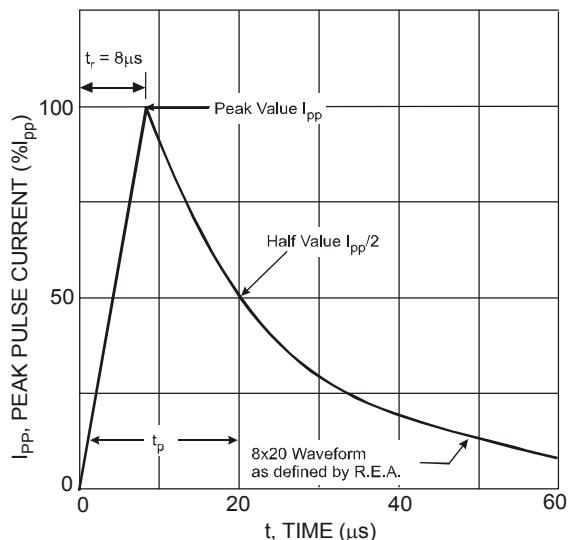


Figure 3 Typical 8 x 20µs Pulse Waveform

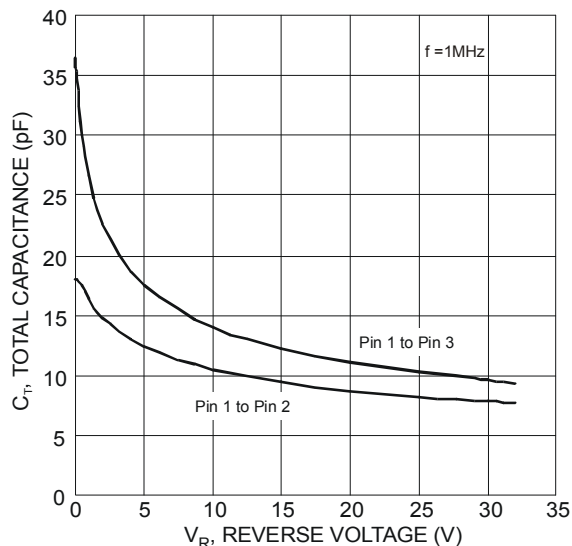


Figure 4 Typical Total Capacitance vs. Reverse Voltage

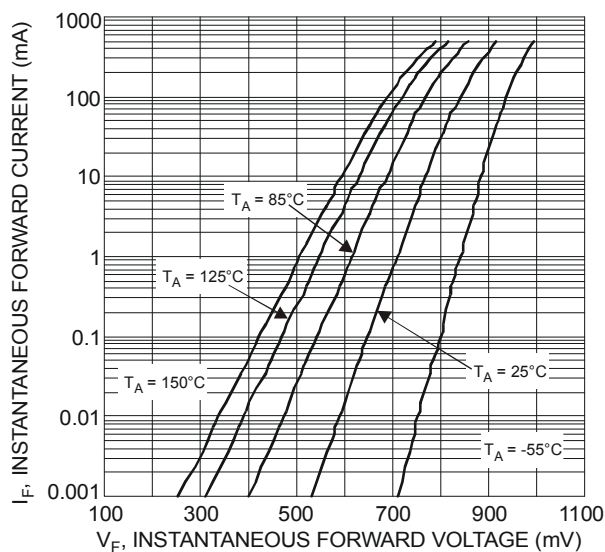


Figure 5 Typical Forward Characteristics

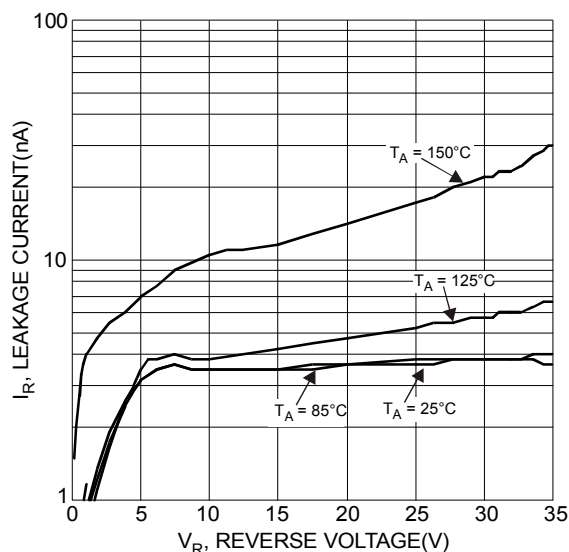
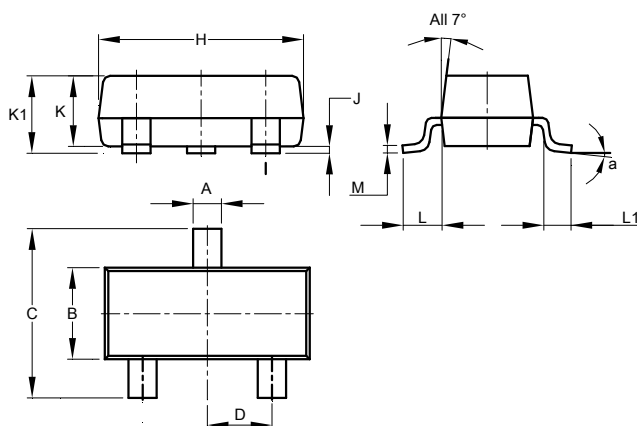


Figure 6 Typical Reverse Characteristics

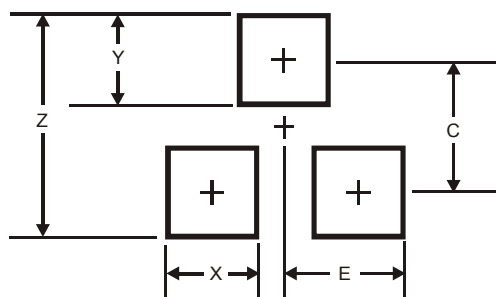
Package Outline Dimensions

 Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.


SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	8°		
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35

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